# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
XIN WU	04/13/2022
CHUN WANG	04/13/2022
BO ZHENG	04/13/2022
ZHENGUO MA	04/14/2022

#### **RECEIVING PARTY DATA**

Name:	BEIJING NAURA MICROELECTRONICS EQUIPMENT CO., LTD.
Street Address:	NO.8 WENCHANG AVENUE
Internal Address:	BEIJING ECONOMIC-TECHNOLOGICAL DEVELOPMENT AREA
City:	BEIJING
State/Country:	CHINA
Postal Code:	100176

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17769841

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	00191.0076.00US
NAME OF SUBMITTER:	GRACE XIA
SIGNATURE:	/GRACE XIA/
DATE SIGNED:	04/18/2022

**Total Attachments: 3** 

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# ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:

# ETCHING METHOD, AIR-GAP DIELECTRIC LAYER, AND DYNAMIC RANDOM-ACCESS MEMORY

for which I/We executed an application for	r United States Letters	Patent concurrently	herewith, as a
national stage in the United States of PC	T Application No. PCT	/CN2020/123648, or	filed an application
for United States Letters Patent on		); and	-

WHEREAS, <u>BELJING NAURA MICROELECTRONICS EQUIPMENT CO., LTD.</u>, a limited company of <u>P.R. China</u>, whose post office address is <u>No.8 Wenchang Avenue</u>. <u>Beijing Economic-Technological Development Area, Beijing 100176, P.R. China</u> (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the	
Declaration and Power of Attorney in this application, to insert here in parentheses (Application No	
filed the filing date and application number of said application when known.	

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IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

lnv	entor 1:	
Name:	Xin WU	
Signature:	24	
Date:	w12.4.1)	ووود ووودو
lnv	rentor 2:	
Name:	Chun WANG	*******
Signature:	<b>注</b>	
Date:	2022. 4.13	
Inv	rentor 3:	
Name:	Bo ZHENG	
Signature:	bo Zlenf	
Date:	2022. 4.13	
	**************************************	

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小咖啡

Anova Law Group, PLLC 00191.0076.00US Inventor 4: Name: Zhenguo MA Signature:

Date:

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**PATENT RECORDED: 04/18/2022** REEL: 059623 FRAME: 0189